



BSI Standards Publication

Field device integration (FDI)®

Part 150-1: Profiles — ISA100

National foreword

This British Standard is the UK implementation of EN IEC 62769-150-1:2023. It is identical to IEC 62769-150-1:2023. It supersedes BS EN IEC 62769-150-1:2021, which is withdrawn.

The UK participation in its preparation was entrusted to Technical Committee GEL/65/5, Devices and integration in enterprise systems.

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Amendments/corrigenda issued since publication

Date	Text affected
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English Version

Field device integration (FDI)® - Part 150-1: Profiles - ISA100
(IEC 62769-150-1:2023)

Intégration des appareils de terrain (FDI)® - Partie 150-1:
Profils - ISA100
(IEC 62769-150-1:2023)

Feldgeräteintegration (FDI) - Teil 150-1: Profile - ISA100
WIRELESS
(IEC 62769-150-1:2023)

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Comité Européen de Normalisation Electrotechnique
Europäisches Komitee für Elektrotechnische Normung

CEN-CENELEC Management Centre: Rue de la Science 23, B-1040 Brussels

European foreword

The text of document 65E/866/CDV, future edition 2 of IEC 62769-150-1, prepared by SC 65E "Devices and integration in enterprise systems" of IEC/TC 65 "Industrial-process measurement, control and automation" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN IEC 62769-150-1:2023.

The following dates are fixed:

- latest date by which the document has to be implemented at national level by publication of an identical national standard or by endorsement (dop) 2024-02-24
- latest date by which the national standards conflicting with the document have to be withdrawn (dow) 2026-05-24

This document supersedes EN IEC 62769-150-1:2021 and all of its amendments and corrigenda (if any).

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In the official version, for Bibliography, the following note has to be added for the standard indicated:

IEC 62769 (series) NOTE Approved as EN IEC 62769 (series)

Annex ZA (normative)

Normative references to international publications with their corresponding European publications

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 Where an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: www.cenelec.eu.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 62734	2014	Industrial networks - Wireless communication network and communication profiles - ISA 100.11a	EN 62734	2015
IEC 61804	series	Function blocks (FB) for process control and electronic device description language (EDDL)	EN IEC 61804	series
IEC/TR 62541-2	-	OPC unified Architecture - Part 2: Security Model	CLC IEC/TR 62541-2-	
IEC 62541-100	2015	OPC Unified Architecture - Part 100: Device Interface	EN 62541-100	2015
IEC 62769-4	-	Field Device Integration (FDI®) - Part 4: FDI Packages	EN IEC 62769-4	-
IEC 62769-5	-	Field Device Integration (FDI®) - Part 5: FDI Information Model	EN IEC 62769-5	-
IEC 62769-6	-	Field Device Integration (FDI®) - Part 6: FDI Technology Mappings	EN IEC 62769-6	-
IEC 62769-7	-	Field Device Integration (FDI®) - Part 7: Communication Devices	EN IEC 62769-7	-

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

FIELD DEVICE INTEGRATION (FDI®) –

Part 150-1: Profiles – ISA100

FOREWORD

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IEC 62769-150-1 has been prepared by subcommittee 65E: Devices and integration in enterprise systems, of IEC technical committee 65: Industrial-process measurement, control and automation. It is an International Standard.

This second edition cancels and replaces the first edition published in 2021. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) added namespace to Annex A.

The text of this International Standard is based on the following documents:

Draft	Report on voting
65E/866/CDV	65E/923/RVC

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at www.iec.ch/members_experts/refdocs. The main document types developed by IEC are described in greater detail at www.iec.ch/standardsdev/publications.

A list of all parts in the IEC 62769 series, published under the general title *Field device integration (FDI®)*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "<http://webstore.iec.ch>" in the data related to the specific document. At this date, the document will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

FIELD DEVICE INTEGRATION (FDI®) –

Part 150-1: Profiles – ISA100

1 Scope

This part of IEC 62769 specifies an FDI¹ profile of IEC 62769 for IEC 62734 (ISA100.11a)².

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 62734:2014, *Industrial networks – Wireless communication network and communication profiles – ISA 100.11a*

IEC 61804 (all parts), *Devices and integration in enterprise systems – Function blocks (FB) for process control and electronic device description language (EDDL)*

IEC TR 62541-2, *OPC unified architecture – Part 2: Security Model*

IEC 62541-100:2015, *OPC unified architecture – Part 100: Device Interface*

IEC 62734:2014, *Industrial networks – Wireless communication network and communication profiles – ISA 100.11a*

IEC 62769-4, *Field device integration (FDI®) – Part 4: FDI® Packages*

IEC 62769-5, *Field device integration (FDI®) – Part 5: Information Model*

IEC 62769-6, *Field device integration (FDI®) – Part 6: Technology Mapping*

IEC 62769-7, *Field device integration (FDI®) – Part 7: Communication devices*

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